

Thick Film Chip Resistor 0805





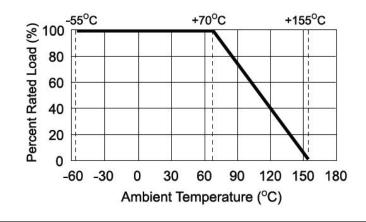
Features

- Small size and light weight
- · Suitable for both wave and reflow soldering
- Reduction of assembly costs

Performance Specification

Temperature Coefficient	: 1Ω to 10Ω ±400PPM/°C 11Ω to 100Ω ±200PPM/°C >100Ω ±100PPM/°C
Short Time Overload	: ±5% : ±(2% +0.1Ω)Max. ±1% : ±(1% +0.1Ω)Max.
Insulation Resistance	: Min. 1,000MΩ
Dielectric Withstanding Voltage	: No evidence of flashover, mechanical damage, arcing or insulation breakdown.
Terminal Bending	: ±(1% +0.05Ω) Max.
Soldering Heat	: ±(1% +0.05Ω) Max.
Solderability	: Min. 95% coverage
Temperature Cycling	: ±5% : ±(1% +0.05Ω) Max. ±1% : ±(0.5% +0.05Ω) Max.
Humidity (Steady State)	: ±5% : ±(3% +0.1Ω) Max. ±1% : ±(0.5% +0.1Ω) Max.
Load Life in Humidity	: ±5% : ±(3% +0.1Ω) Max. ±1% : ±(1% +0.1Ω) Max.
Load Life	: ±5% : ±(3% +0.1Ω) Max. ±1% : ±(1% +0.1Ω) Max.

Derating Curve



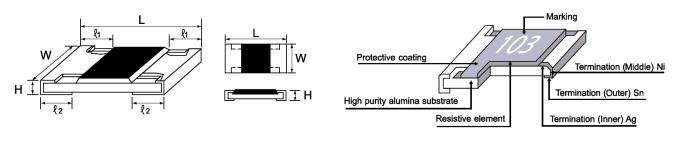




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multicomp

Dimension



Туре	Dimension (mm)						
	L	W	Н	E 1	£ 2		
0805	2 ±0.15	1.25 +0.15 +0.1	0.55 ±0.1	0.4 ±0.2	0.4 ±0.2		

Туре	Power Rating at 70°C	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Tolerance %	Resistance Range
0805	1/8W-S 1/16W	2A	4A	-	Jumper	<50mΩ
		150V	300V	500V	±1% ±2% ±5%	10Ω to 1ΜΩ 1Ω to 10ΜΩ 1Ω to 10ΜΩ



